

### Product Summary

$V_{RRM}$	1200 V
$I_F (T_c=165^\circ\text{C})$	5 A
$Q_c$	32 nC

### Features

- Extremely low reverse current
- No reverse recovery current
- Temperature independent switching
- Positive temperature coefficient on  $V_F$
- Excellent surge current capability
- Low capacitive charge

### Benefits

- Essentially no switching losses
- System efficiency improvement over Si diodes
- Increased power density
- Enabling higher switching frequency
- Reduction of heat sink requirements
- System cost savings due to smaller magnetics
- Reduced EMI

### Applications

- Switch mode power supplies (SMPS)
- Uninterruptible power supplies
- Motor drivers
- Power factor correction

### Package Pin Definitions

- Pin1 and backside - Cathode
- Pin2 - Anode

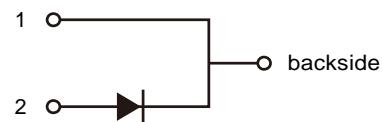
### Package Parameters

Part Number	Marking	Package
B2D05120K1	B2D05120K1	TO-220-2

### Package: TO-220-2



### Electrical Connection



Maximum Ratings ( $T_c=25^\circ\text{C}$  unless otherwise specified)

Symbol	Parameter	Test conditions	Value	Unit
$V_{RRM}$	Repetitive peak reverse voltage		1200	V
$V_{RSM}$	Non-repetitive peak reverse voltage		1200	V
$I_F$	Continuous forward current	$T_c=25^\circ\text{C}$ $T_c=165^\circ\text{C}$	25 5	A
$I_{FSM}$	Non-repetitive forward surge current	$T_c=25^\circ\text{C}, t_p=10\text{ms}$ Half sine wave	55	A
$\int i^2 dt$	i <sup>2</sup> t value	$T_c=25^\circ\text{C}, t_p=10\text{ms}$	15	A <sup>2</sup> S
$P_{tot}$	Power dissipation	$T_c=25^\circ\text{C}$ $T_c=110^\circ\text{C}$	147 64	W
$T_j$	Operating junction temperature		-55~175	°C
$T_{stg}$	Storage temperature		-55~175	°C
	TO-220 mounting torque	M3 Screw	0.7	Nm

## Thermal Characteristics

Symbol	Parameter	Value			Unit
		Min.	Typ.	Max.	
$R_{th(jc)}$	Thermal resistance from junction to case		1.02		K/W

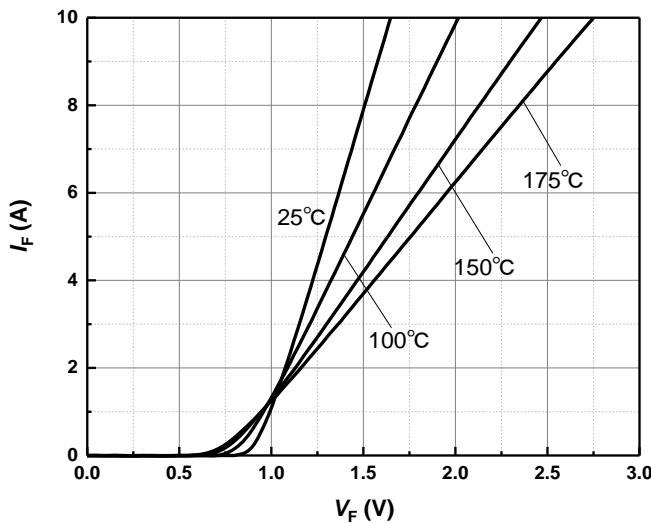
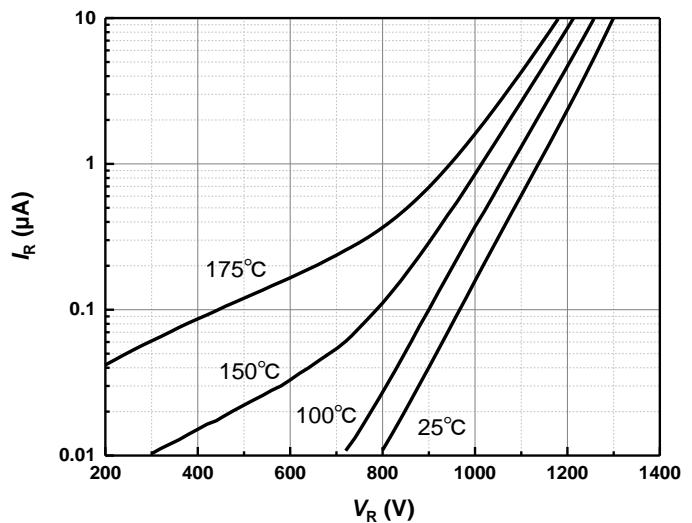
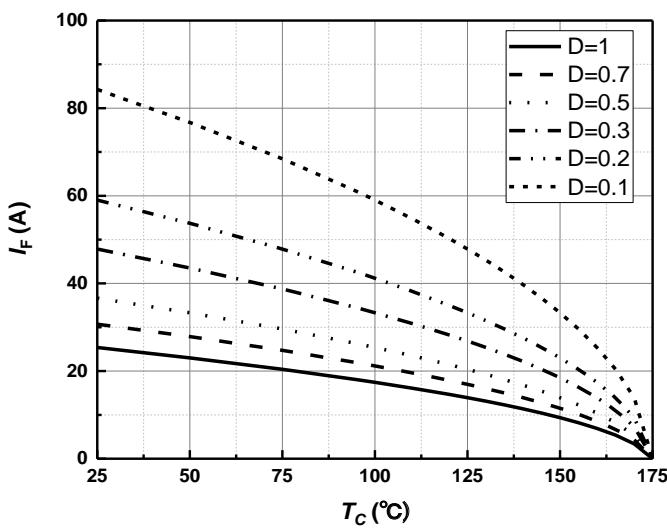
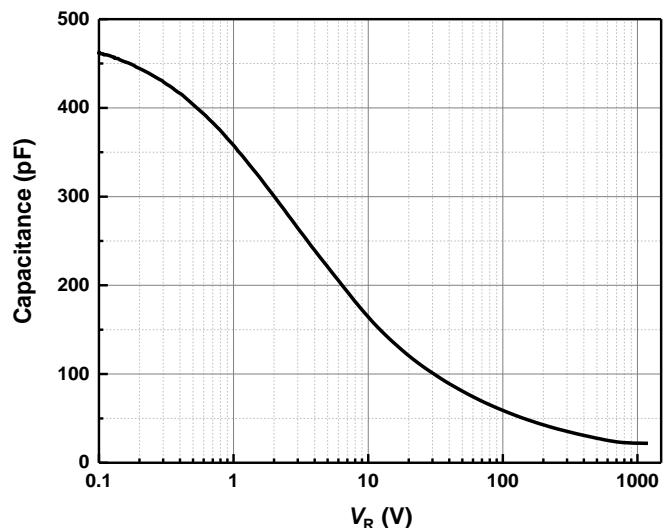
## Electrical Characteristics

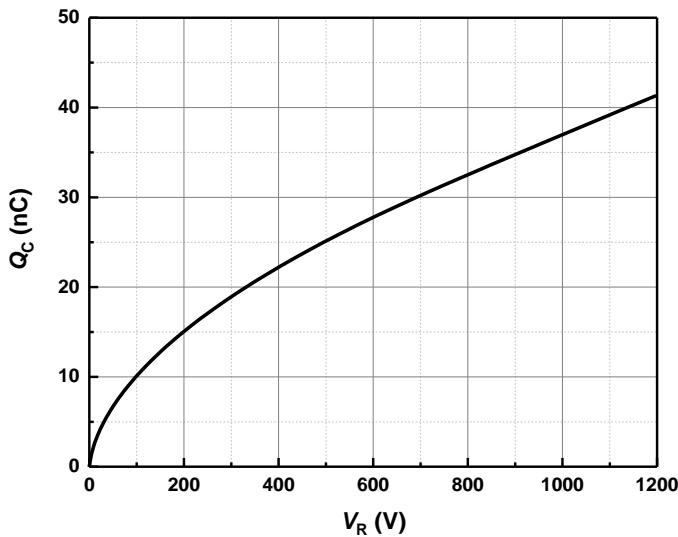
## Static Characteristics

Symbol	Parameter	Test conditions	Value			Unit
			Min.	Typ.	Max.	
$V_{DC}$	DC blocking voltage	$T_j=25^\circ C$	1200			V
$V_F$	Diode forward voltage	$I_F=5A T_j=25^\circ C$ $I_F=5A T_j=175^\circ C$		1.3 1.75	1.6 2.6	V
$I_R$	Reverse current	$V_R=1200V T_j=25^\circ C$ $V_R=1200V T_j=175^\circ C$		5 30	90 300	$\mu A$

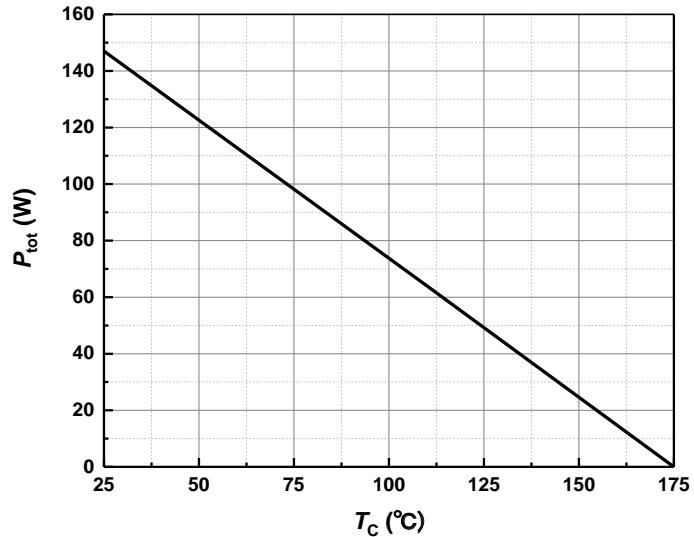
## AC Characteristics

Symbol	Parameter	Test conditions	Value			Unit
			Min.	Typ.	Max.	
$Q_C$	Total capacitive charge	$V_R=800V T_j=25^\circ C$ $Q_C=\int_0^{V_R} C(V)dV$		32		nC
C	Total capacitance	$V_R=1V f=1MHz$ $V_R=400V f=1MHz$ $V_R=800V f=1MHz$		356 30 23		pF
$E_C$	Capacitance stored energy	$V_R=800V$		16		$\mu J$

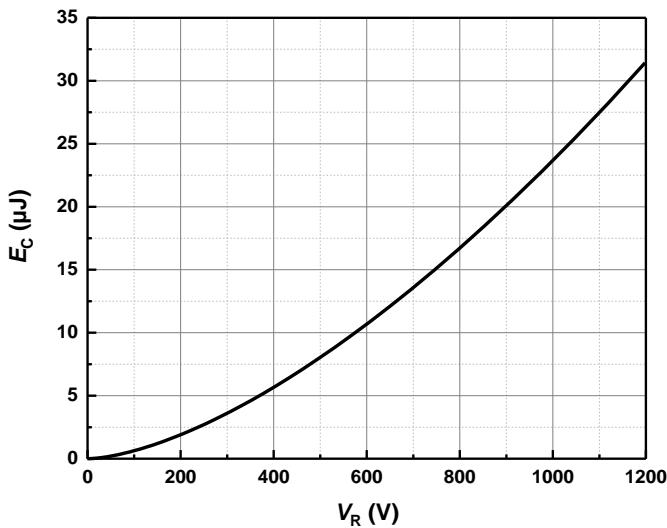
**Typical Performance**

**Figure 1** Typical forward characteristics

**Figure 2** Typical reverse current as function of reverse voltage

**Figure 3** Diode forward current as function of temperature, D=duty cycle

**Figure 4** Typical capacitance as function of reverse voltage,  $C=f(V_R)$ ;  $T_j=25^\circ\text{C}$ ;  $f=1 \text{ MHz}$

**Typical Performance**


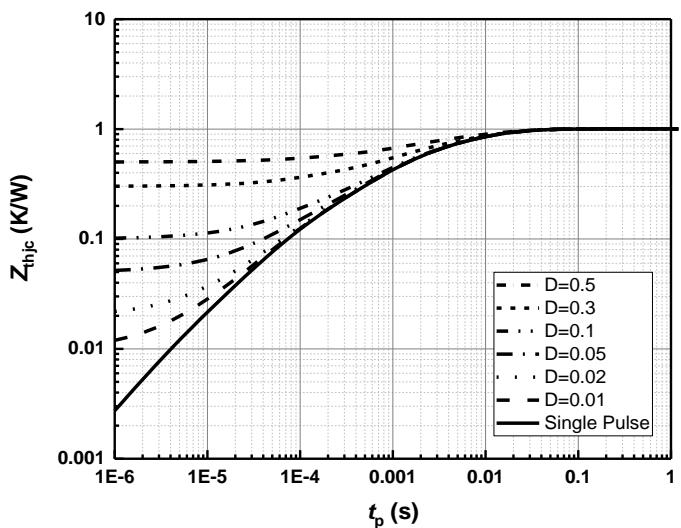
**Figure 5** Typical reverse charge as function of reverse voltage



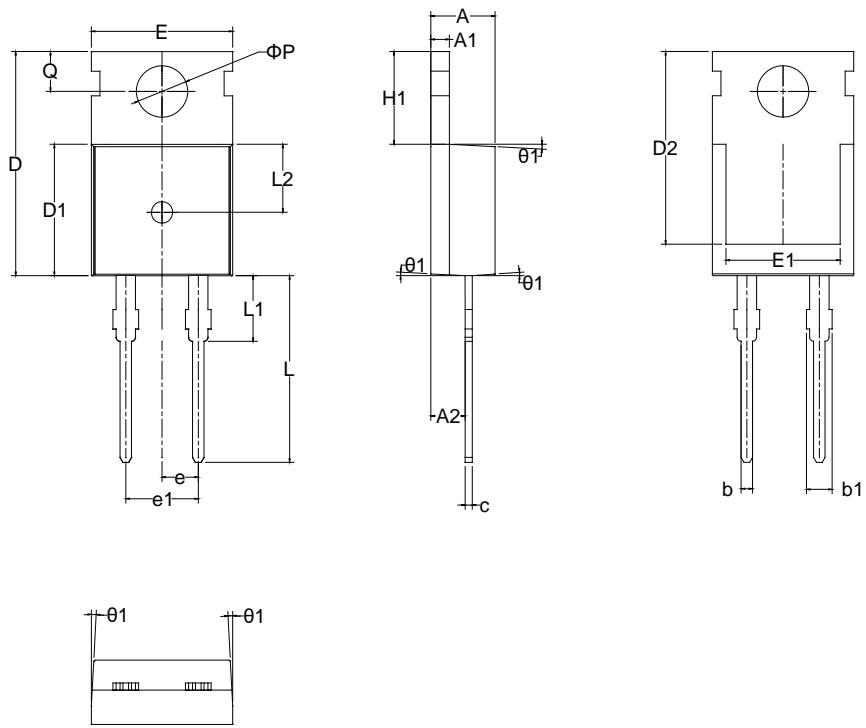
**Figure 6** Power dissipation as function of case temperature



**Figure 7** Capacitance stored energy



**Figure 8** Max. transient thermal impedance,  $Z_{thjc} = f(t_p)$ , parameter:  $D = t_p / T$

**Package Dimensions**


SYMBOL	mm		
	MIN	NOM	MAX
A	4.37	4.57	4.77
A1	1.22	-	1.40
A2	2.49	2.69	2.89
b	0.75	-	0.96
b1	1.22	-	1.47
c	0.30	-	0.48
D	15.15	15.45	15.75
D1	8.82	9.05	9.25
D2	11.40	-	12.88
E	9.86	10.16	10.36
E1	6.86	-	8.89
e	2.54 BSC		
e1	5.08 BSC		
H1	6.10	6.30	6.50
L	12.70	-	13.70
L1	-	-	4.10
L2	2.50 REF		
ΦP	3.70	3.84	3.99
Q	2.54	-	2.94
θ1	5°	7°	9°

## Revision History

Document Version	Date of Release	Description of Changes
Rev 0.0	2022-07-11	Release of the datasheet.

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